

1A,50-1000V Fast Recovery Rectifiers

Features

- Low leakage current
- Low forward voltage drop
- Glass passivated chip junction
- Moisture sensitivity: level 1, per J-STD-020
- Halogen-free according to IEC 61249-2-21 definition
- High temperature soldering guaranteed: 260°C/10 seconds



Applications

For use of fast switching rectification in lighting, cellular phone, portable device, power supplies and other consumer applications.

Maximum Ratings & Electrical Characteristics(TA=25°C unless otherwise noted)									
Parameter	Symbol	FF1S	FF2S	FF3S	FF4S	FF5S	FF6S	FF7S	Unit
Maximum repetitive peak reverse voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	IF(AV)	1			А				
Peak forward surge current,8.3ms single half sine- wave superimposed on rated load per diode	IFSM	25			A				
Operating junction temperature range	TJ	-55 to +150			°C				
Storage temperature range	Tstg	-55 to +150			°C				

Thermal-Mechanical Specifications (TA=25°C unless otherwise noted)					
Parameter	Symbol	Тур	Unit		
Thermal Resistance, Junction to Ambient	R _{θJA}	100	°C /W		
Thermal Resistance, Junction to Case	Rejc	20	°C /W		
Thermal Resistance, Junction to Lead	R _{θJL}	20	°C /W		



Electrical Specifications(TA=25°C unless otherwise noted)										
Parameter	Symbol	Test Conditions	FF1S	FF2S	FF3S	FF4S	FF5S	FF6S	FF7S	Unit
Forward Drop Voltage	VF	I⊧=1A		1.3				V		
Reverse	IR	TJ =25℃	T _J =25℃ 5							
leakage I _R current @VR	T」=125℃	50					uA			
Typical junction capacitance	CJ	4.0 V 1 MHZ	5.4				pF			
Maximum reverse	trr	I _F =0.5A, I _R =1.0A,		1!	50		250	5(00	nS
recovery time		I _{RR} =0.25A					200			

Note:

1. Mounted on copper pad area of 0.2x0.2" (5.0 x 5.0mm) to each terminal.



Ratings and Characteristics Curves

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

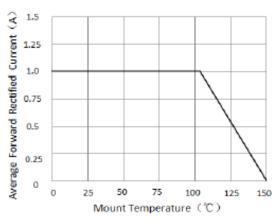
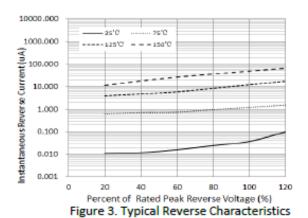


Figure 1.Forward Current Derating Curve



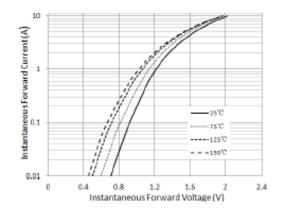
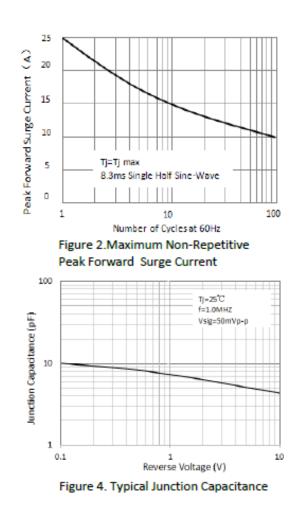


Figure 5. Typical Instantaneous Forward Characteristics

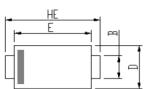




Package Outline Dimensions

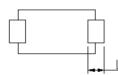
in inches (millimeters)

eSGA (SOD-123FL)



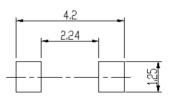






DIM	Unit:	mm	Unit:	t: inch		
	MIN	MAX	MIN	MAX		
А	0.9	1.08	0.035	0.043		
A1	0	0.1	0.000	0.004		
В	0.85	1.05	0.033	0.041		
С	0.1	0.25	0.004	0.010		
D	1.7	2	0.067	0.079		
Е	2.9	3.1	0.114	0.122		
L	0.43	0.83	0.017	0.033		
HE	3.5	3.9	0.138	0.154		

Soldering footprint



Revision History

Document Version	Date of release	Description of changes
Rev.A	2021.06.01	Released Datasheet
Rev.B	2023.10.11	Modify document format



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